

In the Specification:

Please amend paragraph 1 on page 1 as follows:

The present application is related to U.S. Patent Application No. 09/876,967 /
(~~Attorney Docket No. CISC217~~) by Shen et al., and titled Methods and Apparatus for Updating
a Reduction Ratio and related to U.S. Patent Application No. 6,763,070 / (~~Attorney~~
~~Docket No. CISC234~~) by Lee et al., and titled Methods and Apparatus for Selecting a Cut-off
index, both filed on the same day as the present application. Each of the above patent
applications is incorporated herein by reference for all purposes.